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Maruyama(10) **Pub. No.: US 2022/0386454 A1**(43) **Pub. Date: Dec. 1, 2022**(54) **ELECTRONIC CONTROL DEVICE****H05K 1/11** (2006.01)**H05K 3/00** (2006.01)(71) Applicant: **Hitachi Astemo, Ltd.**, Hitachinaka-shi
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The casing of an electronic control device includes a casing-side contact surface in contact with the end of a printed-circuit board. A cover includes a cover-side contact surface holding the end of the printed-circuit board together with the casing-side contact surface by being in contact with the end of the printed-circuit board. In the printed-circuit board, a held portion held between the casing-side contact surface and the cover-side contact surface is provided with a through-hole via.

